SCAS019A – JULY 1987 – REVISED APRIL 1993

- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise
- *EPIC*[™] (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

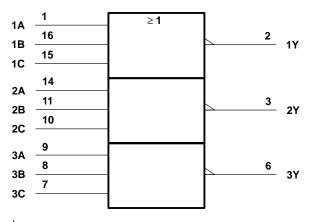
description

These devices contain three independent 3-input NOR gates. They perform the Boolean functions $Y = \overline{A} + \overline{B} + \overline{C}$ or $Y = \overline{A} \cdot \overline{B} \cdot \overline{C}$ in positive logic.

The 54AC11027 is characterized for operation over the full military temperature range of -55° C to 125°C. The 74AC11027 is characterized for operation from -40° C to 85°C.

FUNCTION TABLE (each gate)										
INPUTS OUTPUT										
Α	В	С	Y							
Н	Х	Х	L							
Х	н	Х	L							
Х	Х	н	L							
L	L	L	н							

logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

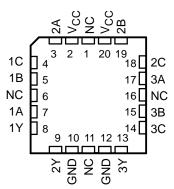
Pin numbers shown are for the D, J, and N packages.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

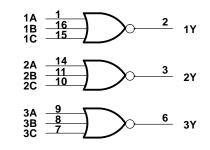
54AC11 74AC11027		DR N	
3Y [1	16	1B
	2	15	1C
	3	14	2A
	4	13	V _{CC}
	5	12	V _{CC}
	6	11	2B
	7	10	2C
	8	9	3A

54AC11027 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	$\dots \dots \dots \dots -0.5$ V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)	-0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0 or V _I > V _{CC})	±20 mA
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions

			54	4AC1102	7	74AC11027		7	UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
V _{CC}	Supply voltage		3	5	5.5	3	5	5.5	V	
		$V_{CC} = 3 V$	2.1			2.1				
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.15			3.15			V	
		V _{CC} = 5.5 V	3.85			3.85				
		$V_{CC} = 3 V$			0.9			0.9		
VIL	Low-level input voltage	$V_{CC} = 4.5 V$			1.35			1.35	V	
		V _{CC} = 5.5 V			1.65			1.65		
VI	Input voltage		0		VCC	0		VCC	V	
VO	Output voltage		0		VCC	0		VCC	V	
		VCC = 3 V			-4			-4		
ЮН	High-level output current	V _{CC} = 4.5 V			-24			-24	mA	
		V _{CC} = 5.5 V			-24			-24		
		V _{CC} = 3 V			12			12	24 mA	
IOL	Low-level output current	V _{CC} = 4.5 V			24			24		
		V _{CC} = 5.5 V			24			24		
$\Delta t/\Delta v$	Input transition rise or fall rate		0		10	0		10	ns/V	
T _A	Operating free-air temperature		-55		125	-40		85	°C	



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	TEST CONDITIONS	N N	Т	4 = 25°C	;	54AC1	1027	74AC11027		UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
Vон		3 V	2.9			2.9		2.9		
	I _{OH} = – 50 μA	4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.4		2.48		V
		4.5 V	3.94			3.7		3.8		V
	I _{OH} = – 24 mA	5.5 V	4.94			4.7		4.8		
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.85				
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V						3.85		
	I _{OL} = 50 μA	3 V			0.1		0.1		0.1	
		4.5 V			0.1		0.1		0.1	
		5.5 V			0.1		0.1		0.1	
Vei	I _{OL} = 12 mA	3 V			0.36		0.5		0.44	V
VOL	I _{OL} = 24 mA	4.5 V			0.36		0.5		0.44	v
	-	5.5 V			0.36		0.5		0.44	
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V					1.65			
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V							1.65	
Ц	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ
ICC	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	5.5 V			4		80		40	μΑ
Ci	$V_I = V_{CC}$ or GND	5 V		3.5						pF

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	FROM TO T _A = 25°C		54AC11027		74AC11027		UNIT		
FARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	4.5%	V	1.5	6.3	9.8	1.5	11.7	1.5	10.9	20
^t PHL	Any	T	1.5	7.6	10.9	1.5	12.9	1.5	12	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T _A = 25°C			54AC11027		74AC11027		UNIT
FARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A. 2014	Y	1.5	4.3	6.8	1.5	8.1	1.5	7.7	ns
^t PHL	Any		1.5	4.5	7.5	1.5	8.9	1.5	8.1	115

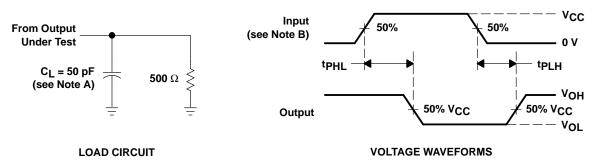
operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per gate	$CL = 50 \text{ pF}, \qquad f = MHz$	24	pF



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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. $C_{\mbox{L}}$ includes probe and jig capacitance.
 - B. Input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r = 3 ns, t_f = 3 ns.
 - C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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